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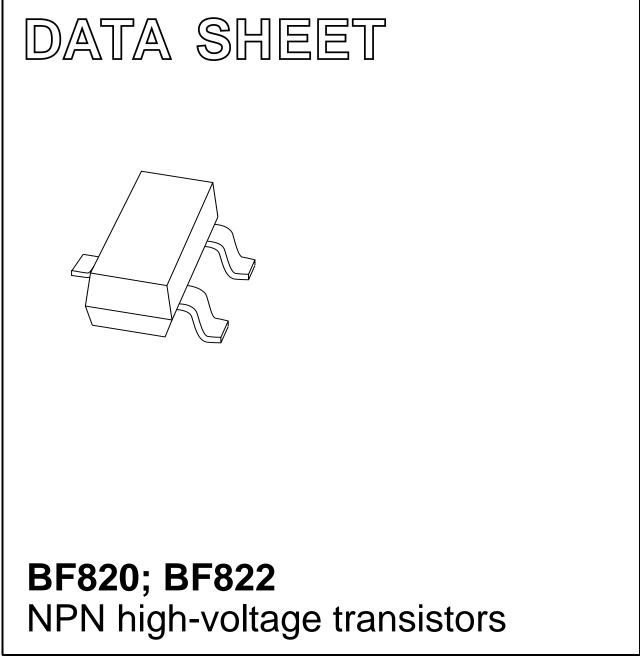
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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 1999 Apr 15 2004 Jan 16



FEATURES

- Low current (max. 50 mA)
- High voltage (max. 300 V).

APPLICATIONS

• Telephony and professional communication equipment.

DESCRIPTION

NPN high-voltage transistor in a SOT23 plastic package. PNP complements: BF821; BF823.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
BF820	1V*
BF822	1X*

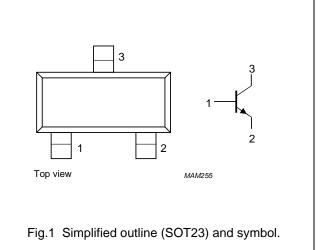
Note

- 1. * = p : Made in Hong Kong.
 - * = t : Made in Malaysia.
 - * = W : Made in China.

ORDERING INFORMATION

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



TYPENUMBER	PACKAGE		
TTPENUMBER	NAME DESCRIPTION		VERSION
BF820	_	plastic surface mounted package; 3 leads	SOT23
BF822	-	plastic surface mounted package; 3 leads	SOT23

BF820; BF822

BF820; BF822

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BF820		-	300	V
	BF822		-	250	V
V _{CEO}	collector-emitter voltage	open base			
	BF820		-	300	V
	BF822		-	250	V
V _{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current (DC)		-	50	mA
I _{CM}	peak collector current		-	100	mA
I _{BM}	peak base current		-	50	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C; note 1$	-	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	500	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

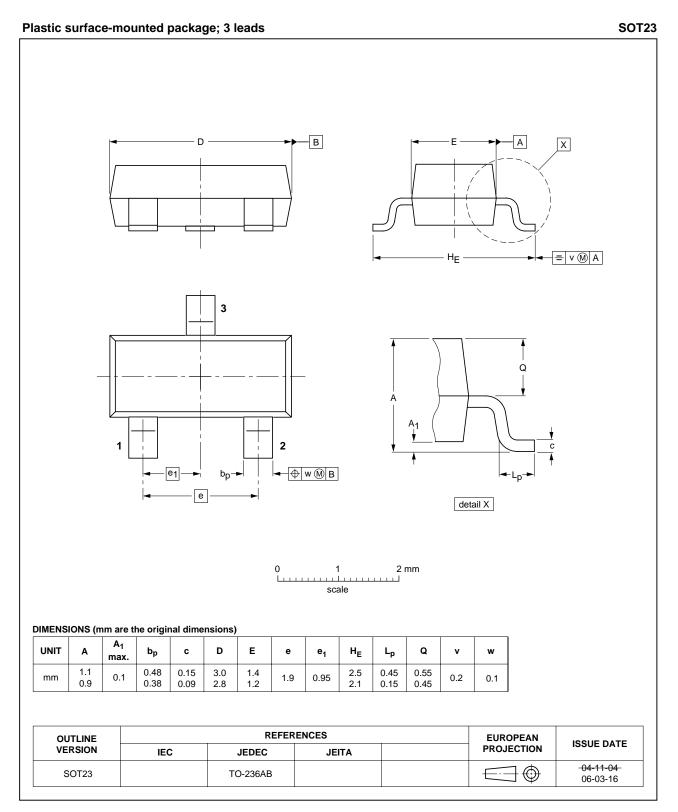
CHARACTERISTICS

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	I _E = 0; V _{CB} = 200 V	-	10	nA
		I _E = 0; V _{CB} = 200 V; T _j =150 °C	-	10	μΑ
I _{EBO}	emitter-base cut-off current	$I_{C} = 0; V_{EB} = 5 V$	-	50	nA
h _{FE}	DC current gain	I _C = 25 mA; V _{CE} = 20 V	50	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 30 mA; I _B = 5 mA	_	600	mV
C _{re}	feedback capacitance	$I_{C} = I_{c} = 0; V_{CB} = 30 V; f = 1 MHz$	-	1.6	pF
f _T	transition frequency	$I_{C} = 10 \text{ mA}; V_{CE} = 10 \text{ V}; \text{ f} = 100 \text{ MHz}$	60	_	MHz

BF820; BF822

PACKAGE OUTLINE



BF820; BF822

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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